CMORE SiGeMEMS マルチプロジェクトウェハ

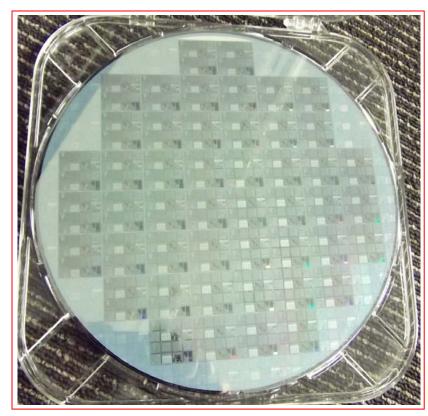


Exhibit #4: Poly-SiGe MEMS MultiProject Wafer (MPW) from the first SiGeMEMS MPW run organized by Europractice in 2011.





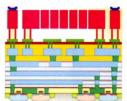
imec CMORE SiGeMEMS MPW

EUROPRACTICE IC Service offers Multi-Project Wafer Services in imec's CMORE SiGeMEMS standalone and SiGeMEMS/CMOS integrated technology:

Imec's CMORE Silicon Germanium MEMS platform technology, referred to as SiGeMEMS, is developed to enable monolithic integration of CMOS and MEMS. Systems integrating MEMS devices with the driving and readout electronics on the same die lead to better performances in terms of signal to noise ratio through reduced interconnect parasitic resistance and capacitance, allow for smaller die size and package, and also for lower power consumption. SiGeMEMS is based on a MEMS-last approach which allows state-of-the-art CMOS

Technology

The SiGeMEMS process, belonging to imec's CMORE service platform, is very versatile. Thanks to its flexible and modular approach, allowing application-specific tuning and optimization, it addresses a large number of applications like gyro's, switches, umicrophones, uspeakers, CMUTs, T-sensors, P-sensors, ... and array type devices like umirrors, probe-based memories, and arrays for ufluidics and upower generation...



EUROPRACTICE now offers a fixed baseline SiGeMEMS process

in a Multi-Project Wafer Service. This unique baseline process consists of MEMS structures defined by an electrode layer and a 4µm-thick SiGe-mechanical layer on top of a TSMC 0.18um CMOS wafer. Nanogaps of 500nm will allow fabrication of extremely small features. A standalone MEMS version, identical but processed on a wafer with a single metal layer, will be available for initial prototyping

Europractice-imec SiGeMEMS MPW runs in 2012

Imec CMORE	2012												
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SIGNEMS MEMS-only								20					
SIGNEMS/TSMC 0 18µm CMOS (CV018LD 1.8/2.3/02V)		Г				10				25 1)			

Technology Version	Standard Price	EU- Discounted Price				
MEMS-only	4250€	4000 €				
CMOS integrated	28500€	27000€				



For more information : epmems@imec.be

www.europractice-ic.com





imec CMORE SiGeMEMS MPW

Principle

Imec's CMORE SIGEMEMS technology offered through the EUROPRACTICE IC MPW service is aimed at creating, characterizing and evaluating test structures prior to further specific development and production projects. By gathering the designs of multiple customers on the same masks set, MPWs allow to fabricate test structures and prototypes of devices at a low cost.

Advantages of SiGeMEMS

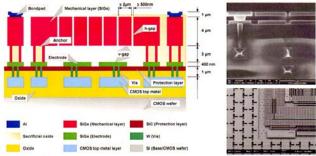
Monolithic integration with IC:

- Very compact
 Best solution for applications that are very sensitive to parasitics
 High intrinsic system reliability: less components, less interconnections

Most flexible with respect to choice of CMOS technology Extremely well suited for MEMS array applications • very high-cently and massive) parallel interconnections possible • lating arrays of MEMS (e.g. juminor arrays)

Poly-SiGe

- High performance: low parasitics Good mechanical properties & reliability better than Al: higher strength and Q factor better than Al: less creep and fatigue
- Summary of SiGeMEMS main features and dimensions



EUROPRACTICE SiGeMEMS MPW Service is accessible for universities and research institutes. (EUROPRACTICE registered mem -> more info at www.europractice-ic.com

repairies can have additional extensions to take advantage of the versatile, flexible and modular technology. Variable layer tricrosses. Application-specific optimization of layer & material properties. Application-specific fortheral about material properties.

- Companies should contact imec CMORE at www.imec.be/cmore

www.europractice-ic.com For more information : epmems@imec.be